

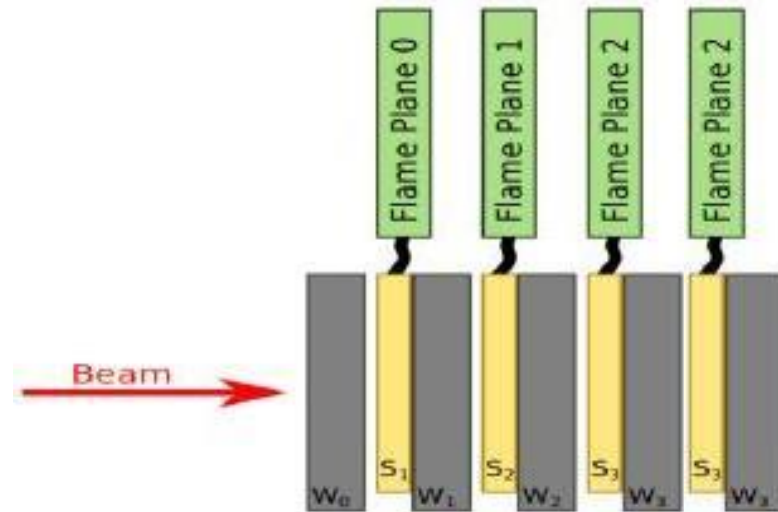
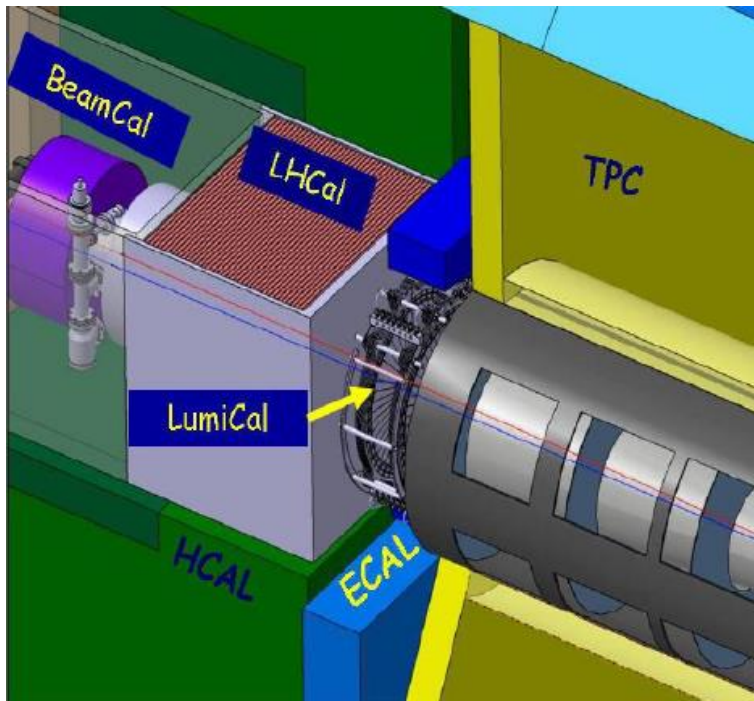
Novel sensors for highly compact electromagnetic calorimeters

The FCAL collaboration and the LUXE ECAL group

Speaker: Anton Tyazhev,
Tomsk State University, Tomsk, Russia

Structure of compact EM calorimeter

W absorber plates interspersed with sensor layers



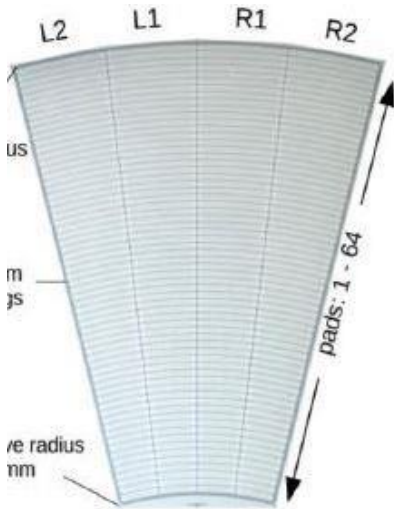
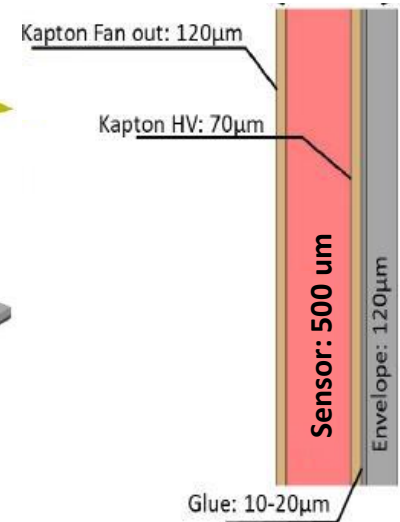
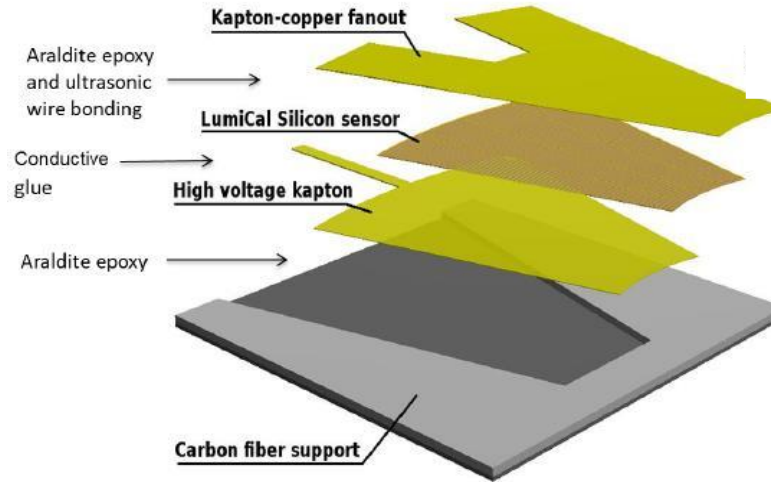
1mm spacing between W plates leads to a Moliere radius equal to the one of W that makes EM compact as the definition

The very forward region of the ILD detector

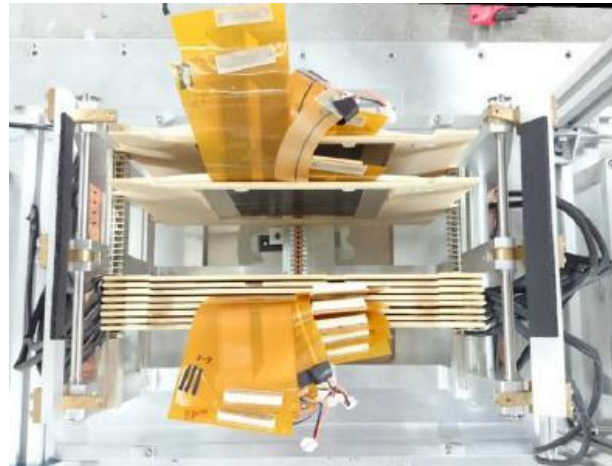
Current sensor design

Sensor assembly
830 um thick

Radiation hard 500 um thick GaAs sensor



320 um thick Si sensor

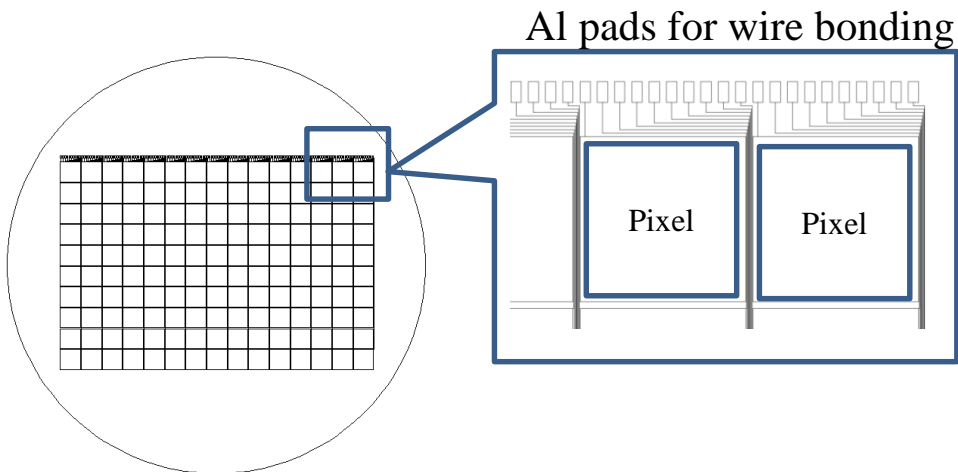


EM calorimeter prototype 2020

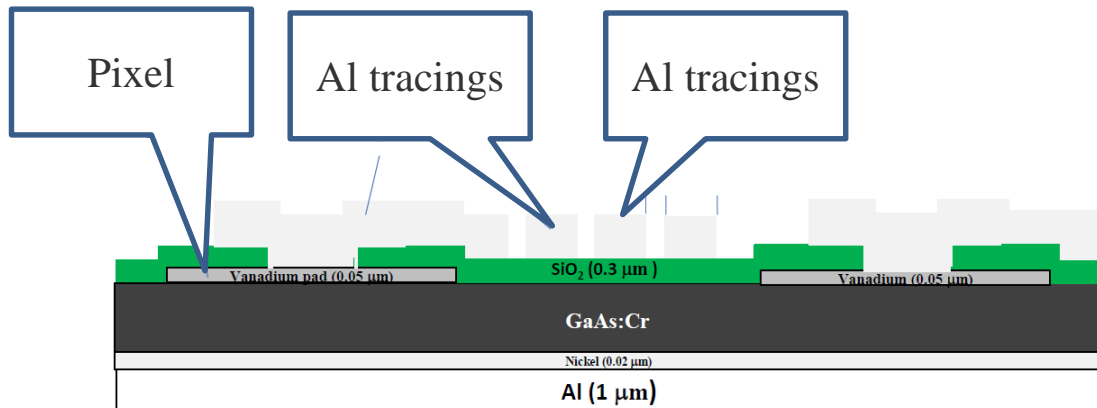
Novel concept: GaAs sensor with tracings

**Thin sensor
assembly 700 μm !**

15x10 pixel array

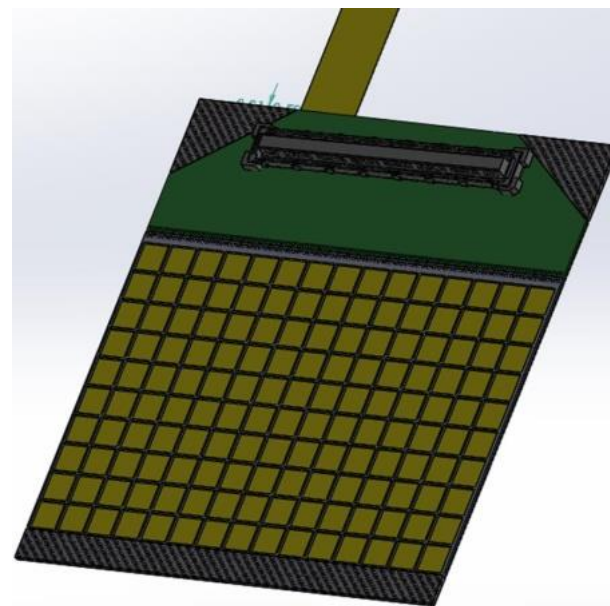


Sensor :	500 μm
Conductive glue (sensor - RO kapton):	100 μm
RO kapton :	100 μm



Cross section of the sensor with tracing (not in scale)

**Compact
sensor module**



Conclusion

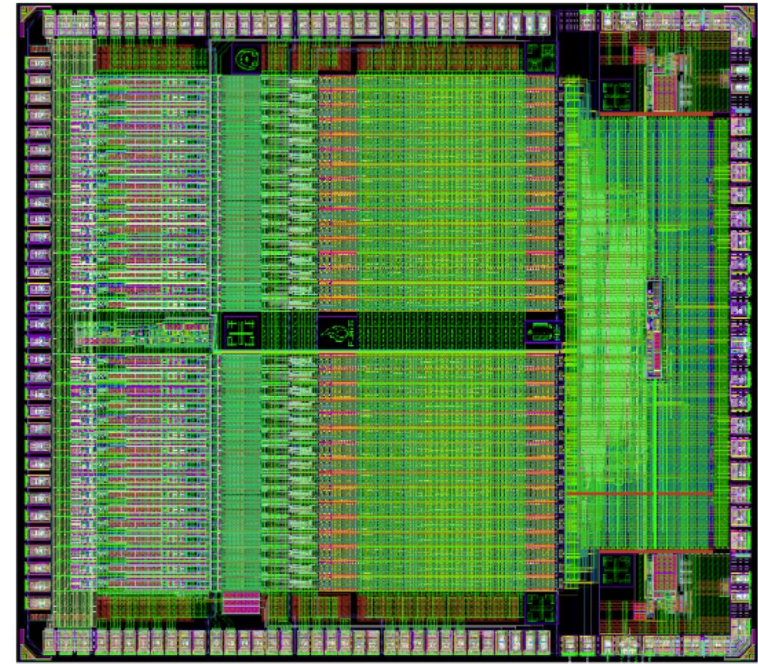
- Sensor with tracings allows to make the sensor planes extremely thin that is the key point for compact electromagnetic calorimeters
- The sensor prototypes will be produced and tested up to the end of 2021

Wireless readout

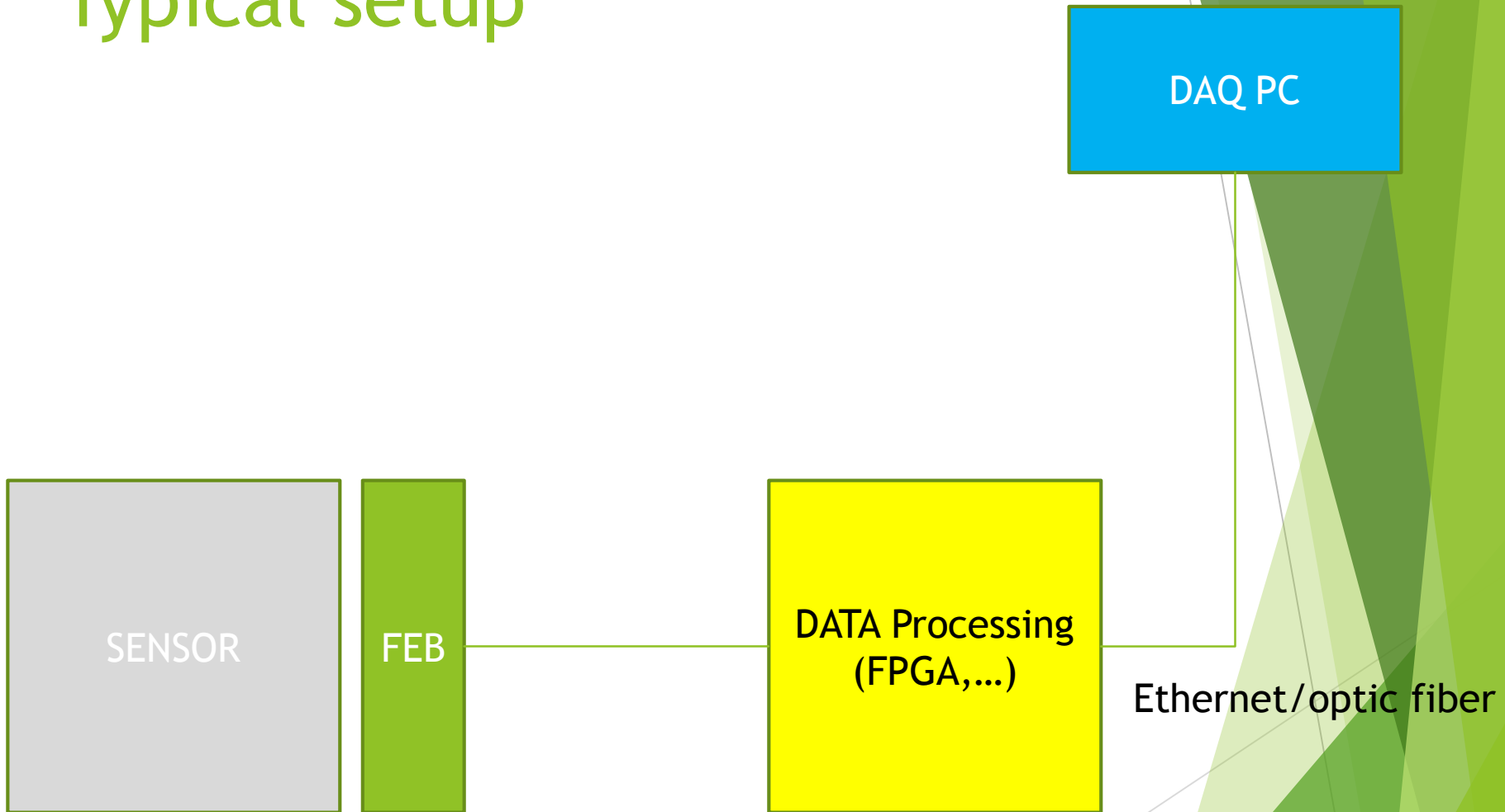
Yan Benhammou
Tel Aviv University

READOUT

- ▶ Sensor signal is send to a dedicated ASIC : FLAME
- ▶ 32 mix mode channel comprising:
 - ▶ Variable gain front end
 - ▶ 10 bit SAR ADC with sampling rate up to 50MSps
 - ▶ Ultra low power consumption
- ▶ Mutli-phase PLL based fast serializer
- ▶ Fast SST driver
- ▶ Two 5.2 Gbps links to the FPGA (we need ~5 FLAME per sensor)
- ▶ From FPGA to DAQ : zero suppressed and trigger so rate depends on the occupancy and event rate

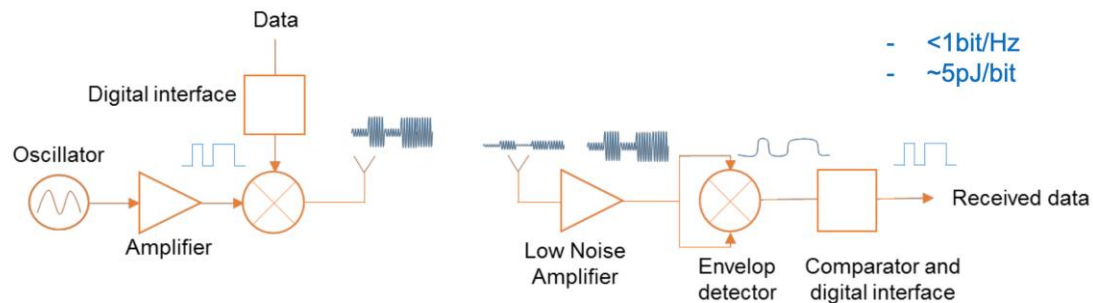
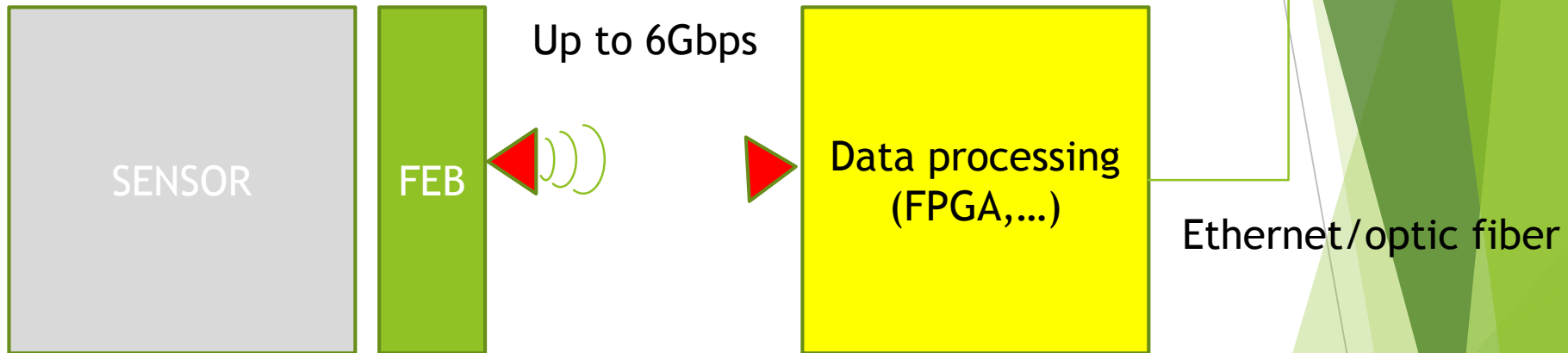


Typical setup



What we want to test

DAQ PC



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Thanks to the WADAPT CERN group